

FCC Confidentiality Request Letter

HACS-F003 FCC Confidentiality Request Letter HCT America LLC (TCB@hctamerica.com) 1726 Ringwood Avenue San Jose, CA 95131 TEL: +1.510.933.8848, Fax: +1.510.933.8849

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REVISION TABLE

Rev	Description of Change	Date	Approved
1.0	Original Release(Obsolete)	06/14/2012	QM
2.0	Updated template(Obsolete)	10/01/2012	QM
2.1	Updated address(Obsolete)	01/10/2014	QM
2.2	Updated address	11/18/2016	QM
3.0	Updated LTC and STC Confidentiality table	11/09/2017	QM



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SOLiD, Inc.

DATE : 5/20/2020

To: Federal Communications Commission Authorization and Evaluation Division 7435 Oakland Mills Road Columbia, MD

SUBJECT : Request for Confidentiality for FCC ID : W6UNHAAWS13

We hereby request confidential treatment of the information accompanying this application as outlined below:

LONG-TERM AND SHORT-TERM CONFIDENTIAL LIST				
	Exhibit	Description		
	1	Block Diagram		
LONG-TERM	2	Operational Description		
CONFIDENTIAL	3	Parts List		
	4	Schematics		
	5	Tune-up Procedure		
SHORT-TERM	6	External Photos		
CONFIDENTIAL	7	Internal Photos		
(180 DAYS)	8	Test-Setup Photos		
(100 DA13)	9	User's Manual		

The above materials contain trade secrets and proprietary information not customarily released to the public. The public disclosure of these materials may be harmful to the applicant and provide unjustified benefits to its competitors.

The applicant understands that pursuant to Section 0.457 & 0.459 of the Rules, disclosure of this application and all accompanying documentation will not be made before the date of the Grant for this application.

Sincerely,

Signed by:

Company Name : SOLiD, Inc. Company Address : 10,9th Floor, SOLiD Space, Pangyoyeok-ro 220, Bundang-gu, Seongnam-si, Gyeonggi-do, South Korea Contact Person Name/Title (in print) : Yong chul Kim/Manager

E-mail: yckim@solid.co.kr